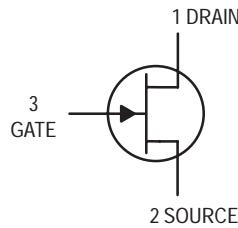


## JFETs Low Frequency/ Low Noise N-Channel — Depletion

**J202**



CASE 29-04, STYLE 5  
TO-92 (TO-226AA)

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	40	Vdc
Drain-Gate Voltage	V <sub>DG</sub>	40	Vdc
Gate-Source Voltage	V <sub>GS</sub>	40	Vdc
Gate Current	I <sub>G</sub>	50	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	310 2.82	mW mW/°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C

### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
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### OFF CHARACTERISTICS

Gate-Source Breakdown Voltage (I <sub>G</sub> = -1.0 μAdc)	V <sub>(BR)GSS</sub>	-40	—	Vdc
Gate Reverse Current (V <sub>GS</sub> = -20 Vdc)	I <sub>GSS</sub>	—	-100	pA
Gate Source Cutoff Voltage (V <sub>DS</sub> = 20 Vdc, I <sub>D</sub> = 10 nAdc)	V <sub>GS(off)</sub>	-0.8	-4.0	Vdc

### ON CHARACTERISTICS

Zero-Gate-Voltage Drain Current <sup>(1)</sup> (V <sub>DS</sub> = 20 Vdc)	I <sub>DSS</sub>	0.9	4.5	mAdc
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### SMALL-SIGNAL CHARACTERISTICS

Forward Transfer Admittance <sup>(1)</sup> (V <sub>DS</sub> = 20 Vdc, f = 1.0 kHz)	y <sub>fs</sub>	1000	—	μmhos
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1. Pulse Width ≤ 2.0 ms.

## TYPICAL CHARACTERISTICS

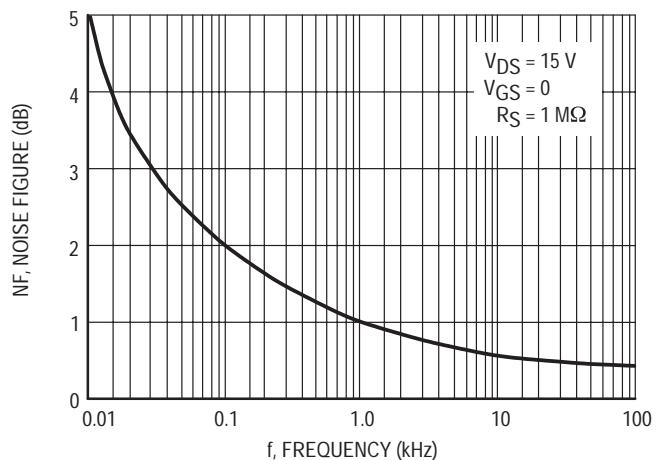


Figure 1. Noise Figure versus Frequency

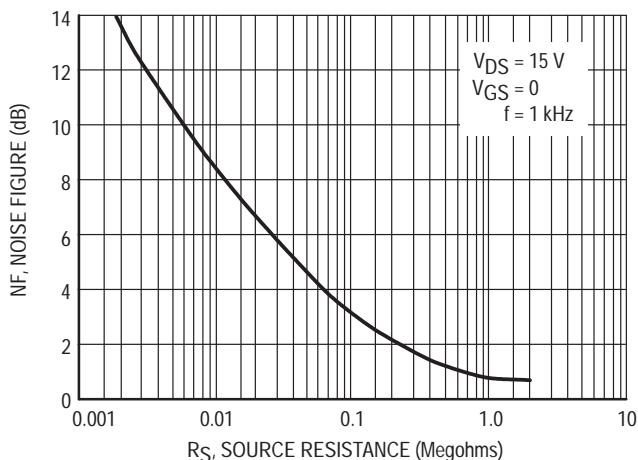


Figure 2. Noise Figure versus Source Resistance

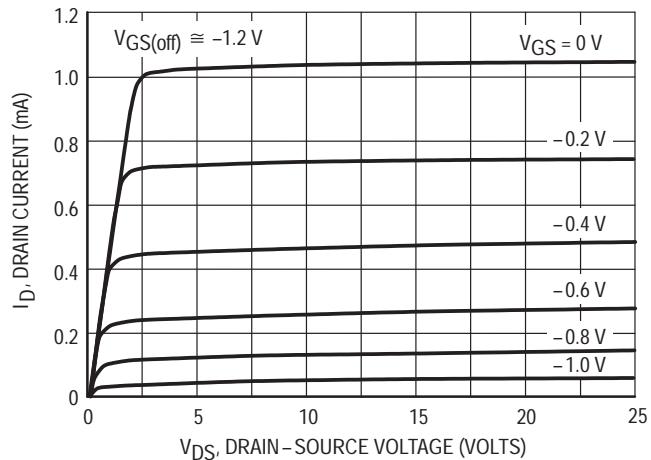


Figure 3. Typical Drain Characteristics

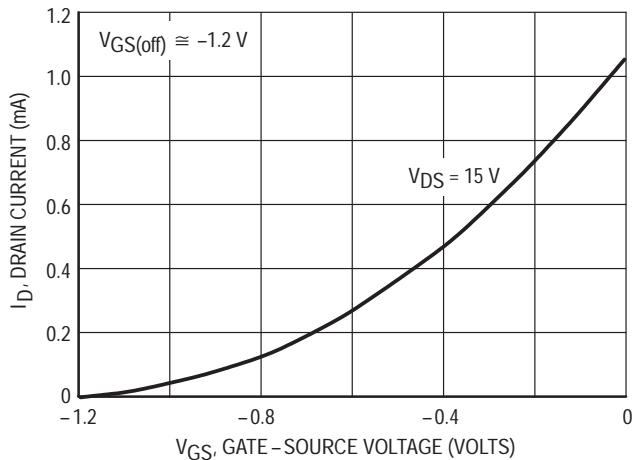


Figure 4. Common Source Transfer Characteristics

## TYPICAL CHARACTERISTICS

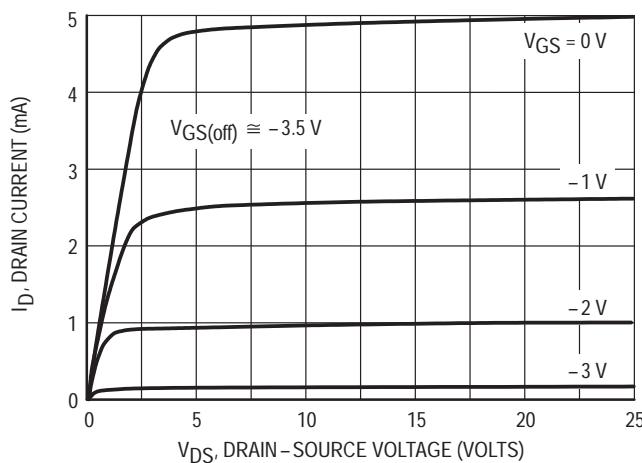


Figure 5. Typical Drain Characteristics

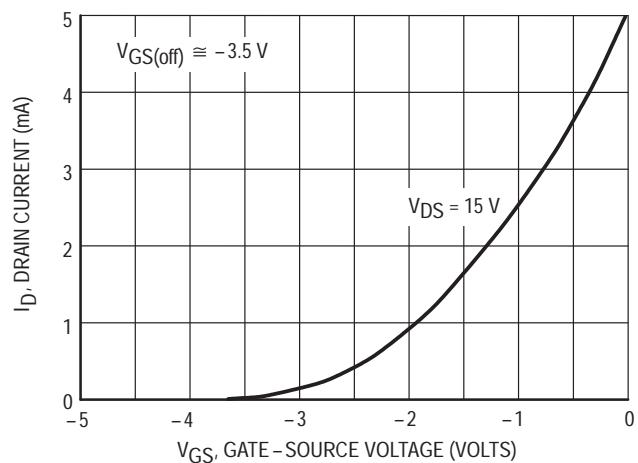


Figure 6. Common Source Transfer Characteristics

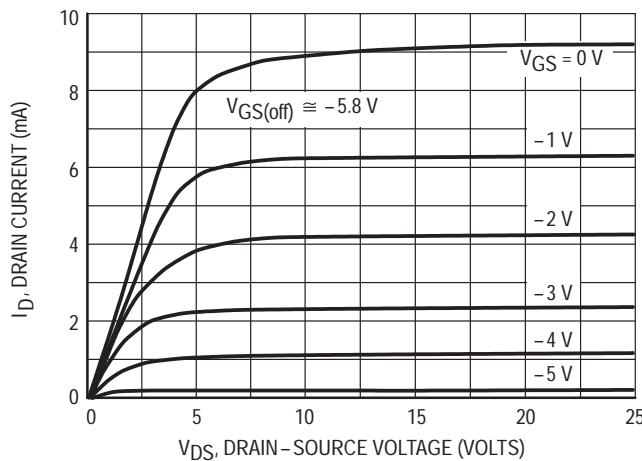


Figure 7. Typical Drain Characteristics

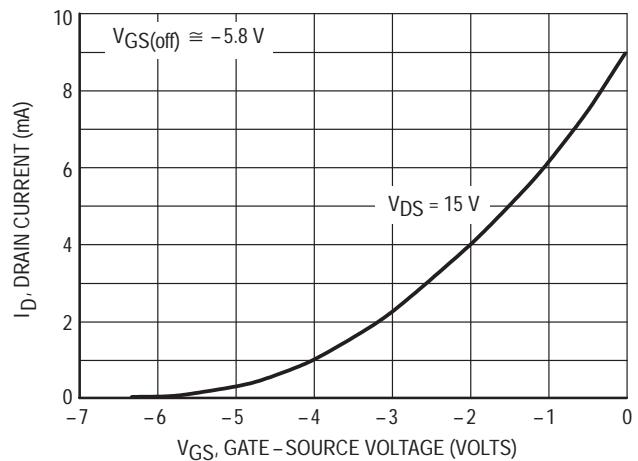


Figure 8. Common Source Transfer Characteristics

Note: Graphical data is presented for dc conditions. Tabular data is given for pulsed conditions (Pulse Width = 630 ms, Duty Cycle = 10%). Under dc conditions, self heating in higher  $I_{DSS}$  units reduces  $I_{DSS}$ .